

Thyristors

BT151 series

GENERAL DESCRIPTION

Passivated thyristors in a plastic envelope, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

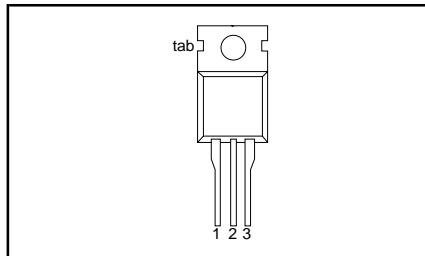
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V_{DRM} , V_{RRM}	Repetitive peak off-state voltages	BT151- 500R 500	650R 650	800R 800	V
$I_{T(AV)}$	Average on-state current	7.5	7.5	7.5	A
$I_{T(RMS)}$	RMS on-state current	12	12	12	A
I_{TSM}	Non-repetitive peak on-state current	100	100	100	A

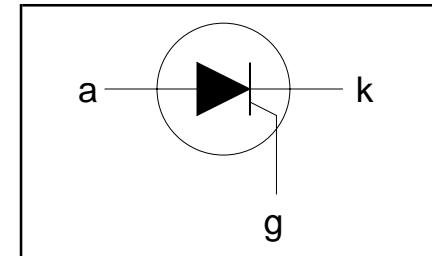
PINNING - TO220AB

PIN	DESCRIPTION
1	cathode
2	anode
3	gate
tab	anode

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DRM} , V_{RRM}	Repetitive peak off-state voltages		-	-500R 500 ¹	V
$I_{T(AV)}$	Average on-state current	half sine wave; $T_{mb} \leq 109^\circ\text{C}$	-	7.5	A
$I_{T(RMS)}$	RMS on-state current	all conduction angles	-	12	A
I_{TSM}	Non-repetitive peak on-state current	half sine wave; $T_j = 25^\circ\text{C}$ prior to surge	-		
I^2t	I^2t for fusing	$t = 10\text{ ms}$	-	100	A
dI_T/dt	Repetitive rate of rise of on-state current after triggering	$t = 8.3\text{ ms}$	-	110	A
I_{GM}	I^2t for fusing	$t = 10\text{ ms}$	-	50	A^2s
V_{GM}	Repetitive rate of rise of on-state current after triggering	$I_{TM} = 20\text{ A}; I_G = 50\text{ mA};$ $dI_G/dt = 50\text{ mA}/\mu\text{s}$	-	50	$\text{A}/\mu\text{s}$
V_{RGM}	Peak gate current		-	2	A
P_{GM}	Peak gate voltage		-	5	V
$P_{G(AV)}$	Peak reverse gate voltage		-	5	V
T_{stg}	Peak gate power		-	5	W
T_j	Average gate power	over any 20 ms period	-	0.5	W
	Storage temperature		-40	150	$^\circ\text{C}$
	Operating junction temperature		-	125	$^\circ\text{C}$

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j\cdot mb}$	Thermal resistance junction to mounting base		-	-	1.3	K/W
$R_{th\ j\cdot a}$	Thermal resistance junction to ambient	in free air	-	60	-	K/W

STATIC CHARACTERISTICS

$T_j = 25^\circ C$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{GT}	Gate trigger current	$V_D = 12 V; I_T = 0.1 A$	-	2	15	mA
I_L	Latching current	$V_D = 12 V; I_{GT} = 0.1 A$	-	10	40	mA
I_H	Holding current	$V_D = 12 V; I_{GT} = 0.1 A$	-	7	20	mA
V_T	On-state voltage	$I_T = 23 A$	-	1.4	1.75	V
V_{GT}	Gate trigger voltage	$V_D = 12 V; I_T = 0.1 A$	-	0.6	1.5	V
I_D, I_R	Off-state leakage current	$V_D = V_{DRM(max)}; I_T = 0.1 A; T_j = 125^\circ C$ $V_D = V_{DRM(max)}; V_R = V_{RRM(max)}; T_j = 125^\circ C$	0.25	0.4	-	V
			-	0.1	0.5	mA

DYNAMIC CHARACTERISTICS

$T_j = 25^\circ C$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV_D/dt	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125^\circ C;$ exponential waveform;				
t_{gt}	Gate controlled turn-on time	Gate open circuit $R_{GK} = 100 \Omega$ $I_{TM} = 40 A; V_D = V_{DRM(max)}; I_G = 0.1 A;$ $dl_G/dt = 5 A/\mu s$	50 200	130 1000 2	-	V/ μs
t_q	Circuit commutated turn-off time	$V_D = 67\% V_{DRM(max)}; T_j = 125^\circ C;$ $I_{TM} = 20 A; V_R = 25 V; dl_{TM}/dt = 30 A/\mu s;$ $dV_D/dt = 50 V/\mu s; R_{GK} = 100 \Omega$	-	70	-	μs

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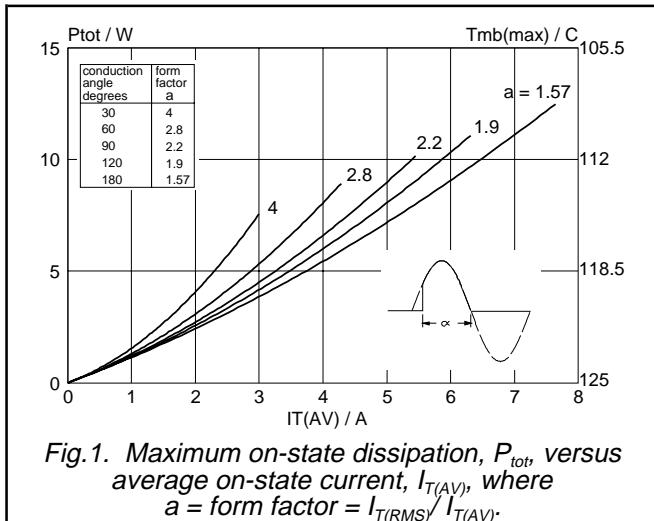


Fig.1. Maximum on-state dissipation, P_{tot} , versus average on-state current, $IT_{(AV)}$, where a = form factor = $I_{T(RMS)} / I_{T(AV)}$.

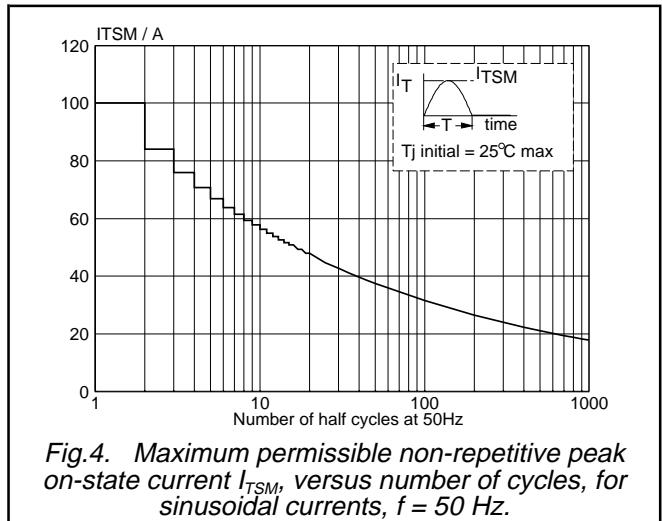


Fig.4. Maximum permissible non-repetitive peak on-state current IT_{SM} , versus number of cycles, for sinusoidal currents, $f = 50$ Hz.

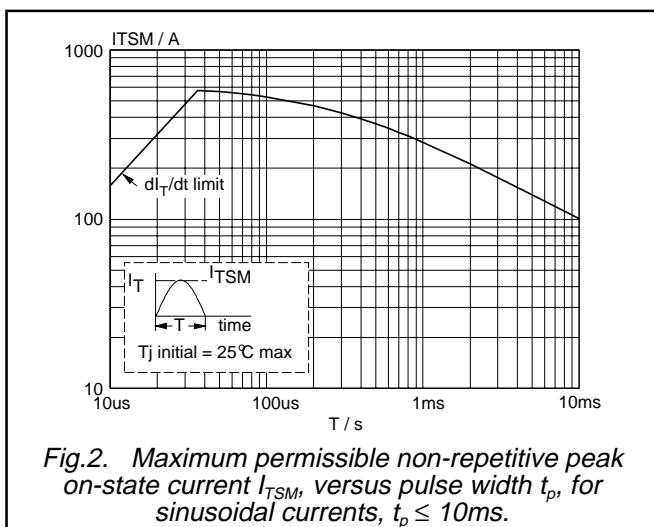


Fig.2. Maximum permissible non-repetitive peak on-state current IT_{SM} , versus pulse width t_p , for sinusoidal currents, $t_p \leq 10\text{ms}$.

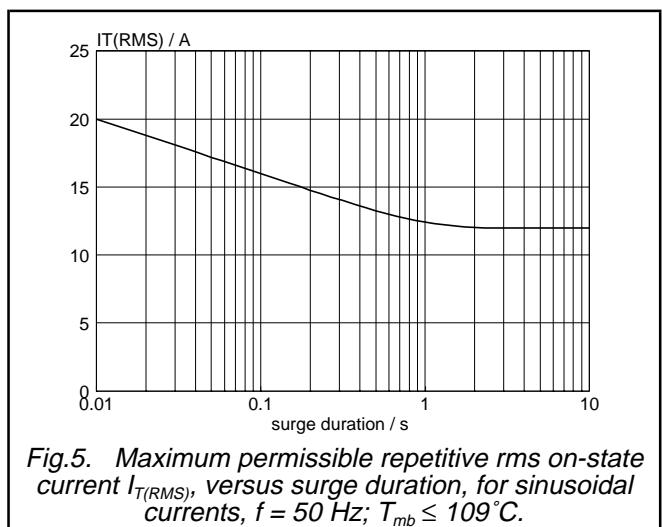


Fig.5. Maximum permissible repetitive rms on-state current $IT_{(RMS)}$, versus surge duration, for sinusoidal currents, $f = 50$ Hz; $T_{mb} \leq 109^\circ\text{C}$.

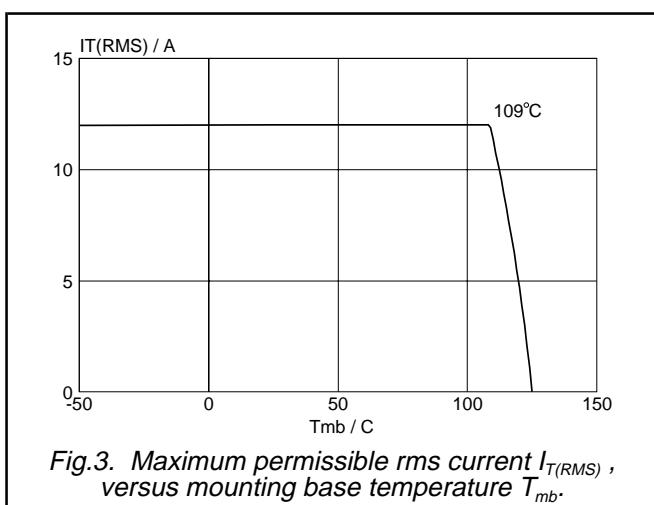


Fig.3. Maximum permissible rms current $IT_{(RMS)}$, versus mounting base temperature T_{mb} .

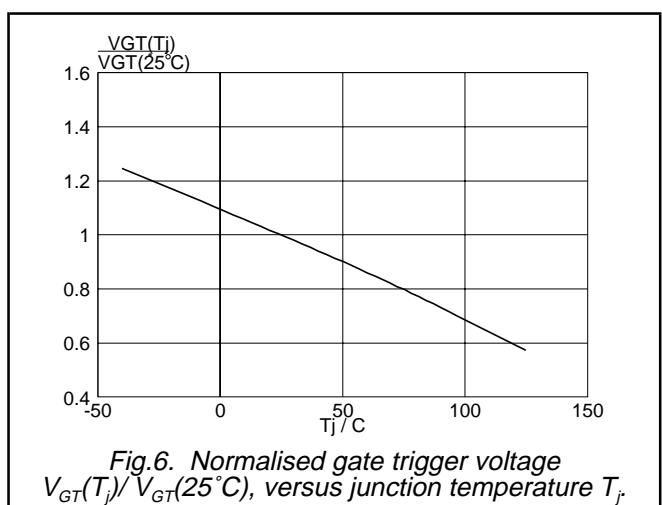


Fig.6. Normalised gate trigger voltage $V_{GT}(T_j) / V_{GT}(25^\circ\text{C})$, versus junction temperature T_j .

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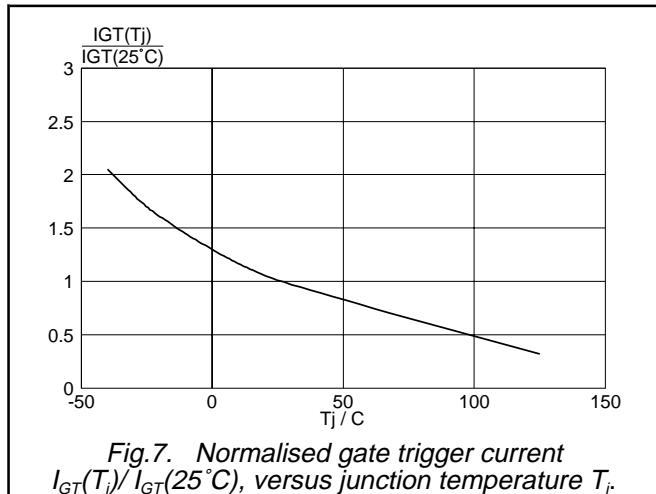


Fig.7. Normalised gate trigger current $I_{GT}(T_j)/I_{GT}(25^\circ\text{C})$, versus junction temperature T_j .

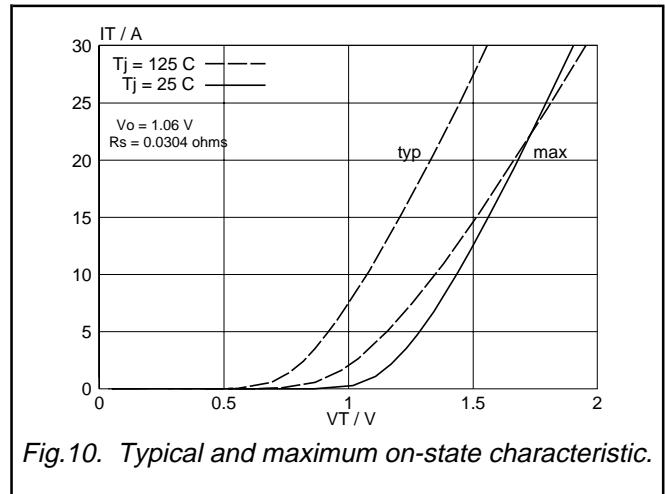


Fig.10. Typical and maximum on-state characteristic.

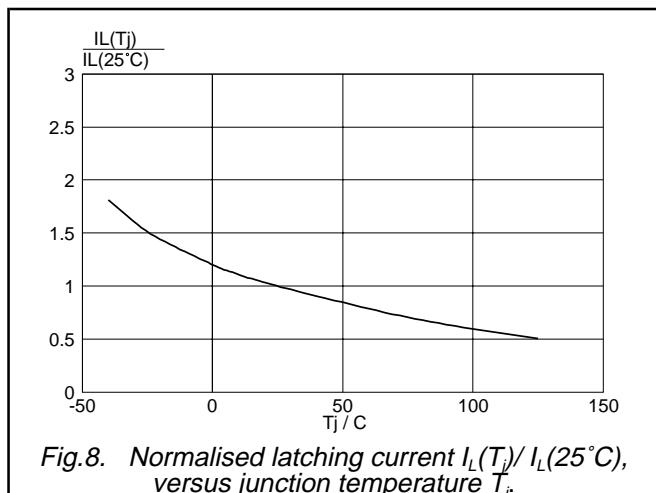


Fig.8. Normalised latching current $I_L(T_j)/I_L(25^\circ\text{C})$, versus junction temperature T_j .

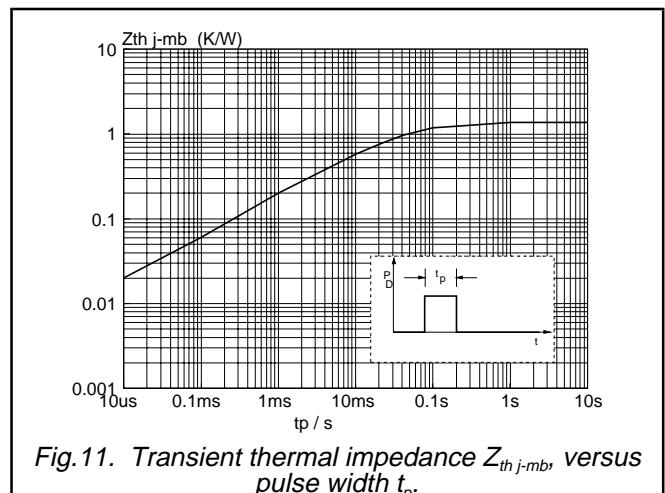


Fig.11. Transient thermal impedance $Z_{th,j-mb}$, versus pulse width t_p .

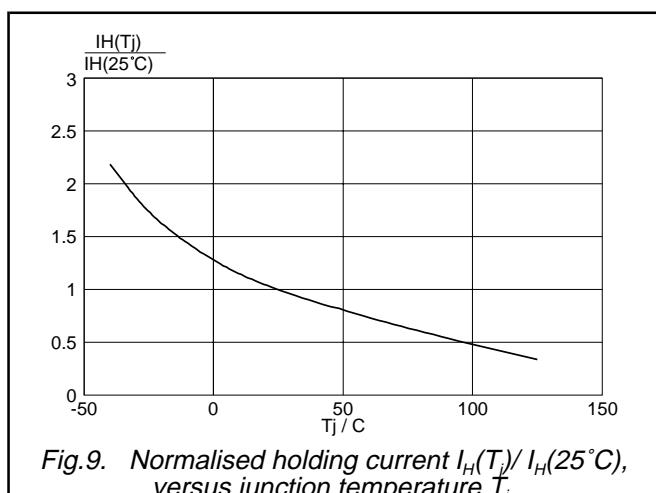


Fig.9. Normalised holding current $I_H(T_j)/I_H(25^\circ\text{C})$, versus junction temperature T_j .

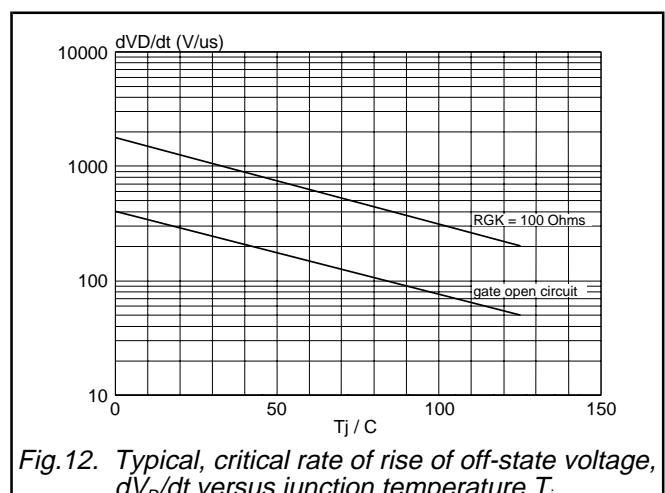


Fig.12. Typical, critical rate of rise of off-state voltage, dV_D/dt versus junction temperature T_j .

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MECHANICAL DATA

Dimensions in mm

Net Mass: 2 g

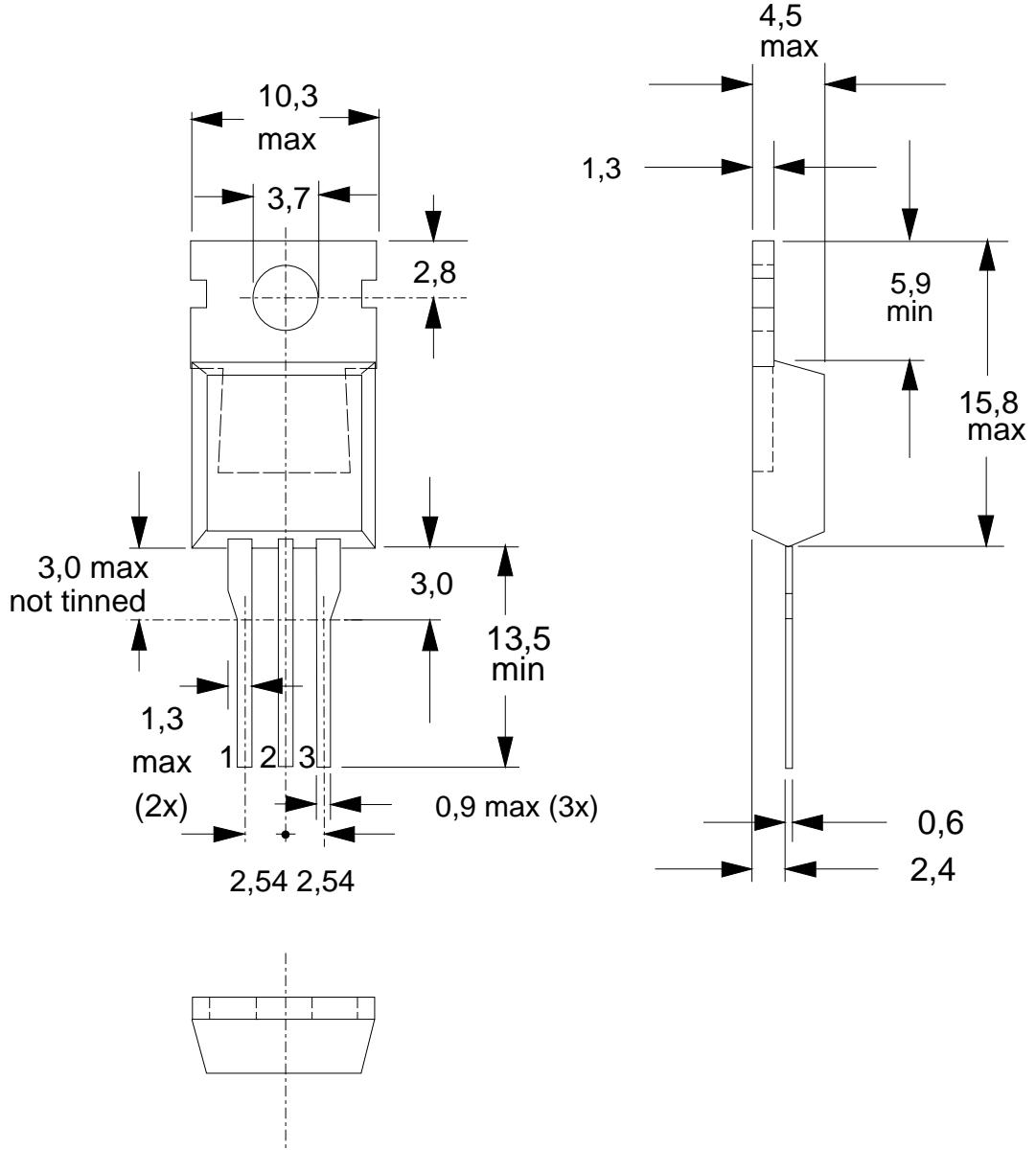


Fig.13. SOT78 (TO220AB). pin 2 connected to mounting base.

Notes

1. Refer to mounting instructions for SOT78 (TO220) envelopes.
2. Epoxy meets UL94 V0 at 1/8".